









(0.50 mm) .0197"

TLH, SLH SERIES

ULTRA-LOW PROFILE TERMINAL

TLH Mates with:

SLF

SLH Mates with:

TLH

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TLH or www.samtec.com?SLH

Insulator Material:

Black Liquid Crystal Polymer Contact Material:
Copper Alloy

Plating: Au over 50 μ" (1.27 μm) Ni

Current Rating: 2.1 A per pin (2 pins powered)

Operating Temp Range: -55 °C to +125 °C

RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity:

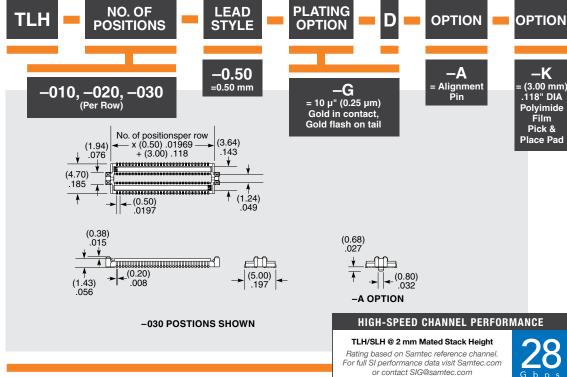
(0.10 mm)™ .004" max Board Stacking:

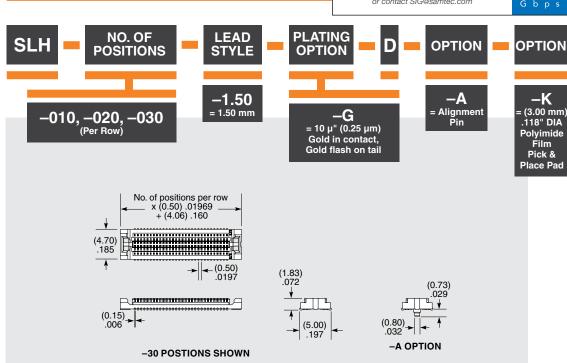
For applications requiring two or more connectors per board, contact ipg@samtec.com

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

FILE NO. E111594





Note:

Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice